

# SCMOS Layout Rule – Well

Rule	Description	Lambda		
		SCMOS	SUBM	DEEP
1.1	Minimum width	10	12	12
1.2	Minimum spacing between wells at different potential	9 <sup>1</sup>	18 <sup>2</sup>	18
1.3	Minimum spacing between wells at same potential	6 <sup>3</sup>	6 <sup>4</sup>	6
1.4	Minimum spacing between wells of different type (if both are drawn)	0	0	0

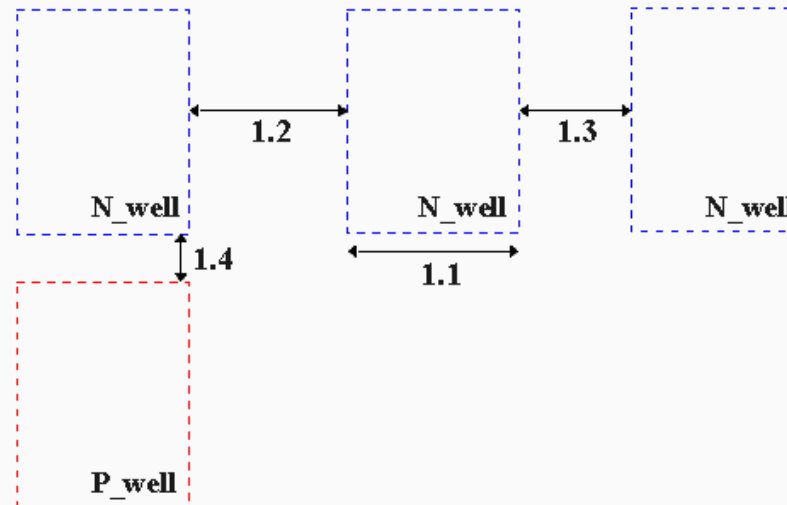
Exceptions for AMIS C30 0.35 micron process:

<sup>1</sup> Use lambda=16 for rule 1.2 only when using SCN4M or SCN4ME

<sup>2</sup> Use lambda=21 for rule 1.2 only when using SCN4M\_SUBM or SCN4ME\_SUBM

<sup>3</sup> Use lambda=8 for rule 1.3 only when using SCN4M or SCN4ME

<sup>4</sup> Use lambda=11 for rule 1.3 only when using SCN4M\_SUBM or SCN4ME\_SUBM

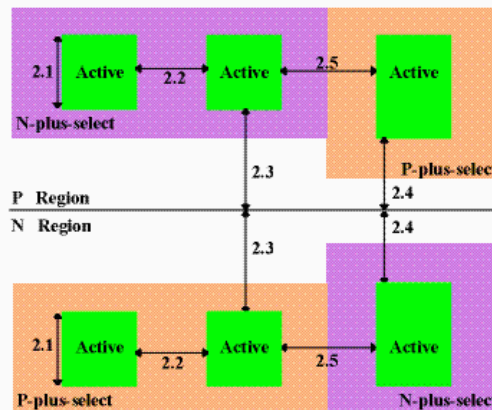


# SCMOS Layout Rule – Active

Rule	Description	Lambda		
		SCMOS	SUBM	DEEP
2.1	Minimum width	3 *	3 *	3
2.2	Minimum spacing	3	3	3
2.3	Source/drain active to well edge	5	6	6
2.4	Substrate/well contact active to well edge	3	3	3
2.5	Minimum spacing between non-abutting active of different implant. Abutting active ("split-active") is illustrated under <a href="#">Select Layout Rules</a> .	4	4	4

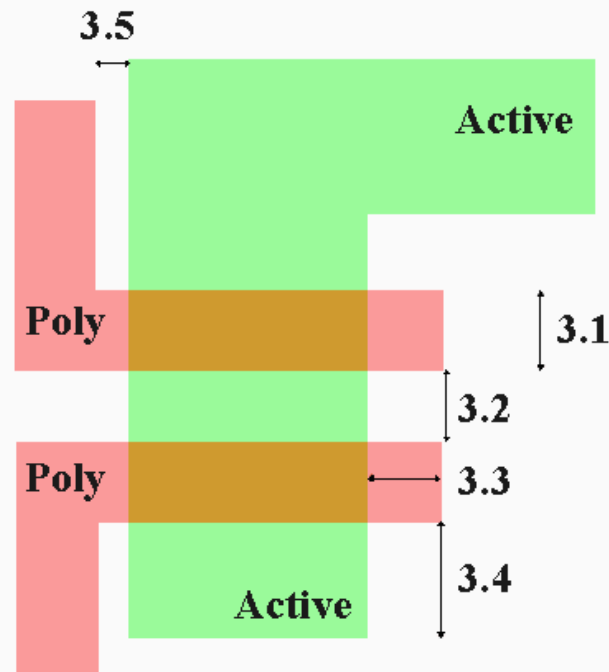
\* Note: For analog and critical digital designs, MOSIS recommends the following minimum MOS channel widths (active under poly) for AMIS designs. Narrower devices, down to design rule minimum, will be functional, but their electrical characteristics will not scale, and their performance is not predictable from MOSIS SPICE parameters.

Process	Design Technology	Design Lambda (micrometers)	Minimum Width (lambda)
AMI_ABN	SCNA, SCNE	0.80	5
AMI_C5F/N	SCN3M, SCN3ME	0.35	9
AMI_C5F/N	SCN3M_SUBM, SCN3ME_SUBM	0.30	10



# SCMOS Layout Rule – Poly

Rule	Description	Lambda		
		SCMOS	SUBM	DEEP
3.1	Minimum width	2	2	2
3.2	Minimum spacing over field	2	3	3
3.2.a	Minimum spacing over active	2	3	4
3.3	Minimum gate extension of active	2	2	2.5
3.4	Minimum active extension of poly	3	3	4
3.5	Minimum field poly to active	1	1	1

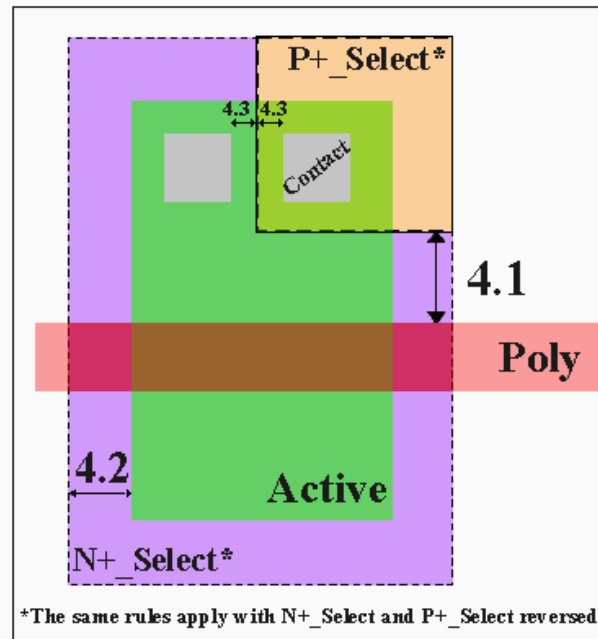


# SCMOS Layout Rule – n+ Select

Rule	Description	Lambda		
		SCMOS	SUBM	DEEP
4.1	Minimum select spacing to channel of transistor to ensure adequate source/drain width	3	3	3
4.2	Minimum select overlap of active	2	2	2
4.3	Minimum select overlap of contact	1	1	1.5
4.4	Minimum select width and spacing (Note: P-select and N-select may be coincident, but must <i>not</i> overlap) (not illustrated)	2	2 <sup>1</sup>	4

Exception for AMIS C30 0.35 micron process:

<sup>1</sup> Use lambda=3 for rule 4.4 only when using SCN4M\_SUBM or SCN4ME\_SUBM

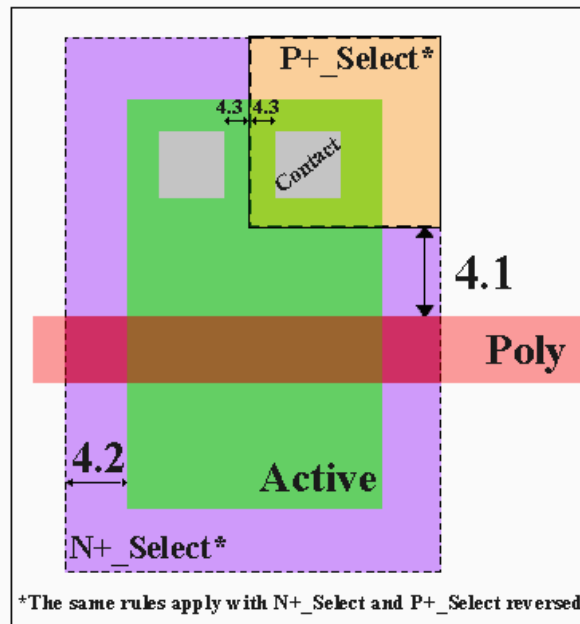


# SCMOS Layout Rule – p+ Select

Rule	Description	Lambda		
		SCMOS	SUBM	DEEP
4.1	Minimum select spacing to channel of transistor to ensure adequate source/drain width	3	3	3
4.2	Minimum select overlap of active	2	2	2
4.3	Minimum select overlap of contact	1	1	1.5
4.4	Minimum select width and spacing (Note: P-select and N-select may be coincident, but must <i>not</i> overlap) (not illustrated)	2	2 <sup>1</sup>	4

Exception for AMIS C30 0.35 micron process:

<sup>1</sup> Use lambda=3 for rule 4.4 only when using SCN4M\_SUBM or SCN4ME\_SUBM



# SCMOS Layout Rule – Contact (Poly)

Simple Contact to Poly					Alternative Contact to Poly				
Rule	Description	Lambda			Rule	Description	Lambda		
		SCMOS	SUBM	DEEP			SCMOS	SUBM	DEEP
5.1	Exact contact size	2x2	2x2	2x2	5.2.b	Minimum poly overlap	1	1	1
5.2	Minimum poly overlap	1.5	1.5	1.5	5.5.b	Minimum spacing to other poly	4	5	5
5.3	Minimum contact spacing	2	3	4	5.6.b	Minimum spacing to active (one contact)	2	2	2
5.4	Minimum spacing to gate of transistor	2	2	2	5.7.b	Minimum spacing to active (many contacts)	3	3	3

**Simple Poly to Contact**

**Alternative Contact to Poly**

# SCMOS Layout Rule – Contact (Active)

Simple Contact to Active					Alternative Contact to Active				
Rule	Description	Lambda			Rule	Description	Lambda		
		SCMOS	SUBM	DEEP			SCMOS	SUBM	DEEP
6.1	Exact contact size	2x2	2x2	2x2	6.2.b	Minimum active overlap	1	1	1
6.2	Minimum active overlap	1.5	1.5	1.5	6.5.b	Minimum spacing to diffusion active	5	5	5
6.3	Minimum contact spacing	2	3	4	6.6.b	Minimum spacing to field poly (one contact)	2	2	2
6.4	Minimum spacing to gate of transistor	2	2	2	6.7.b	Minimum spacing to field poly (many contacts)	3	3	3
					6.8.b	Minimum spacing to poly contact	4	4	4

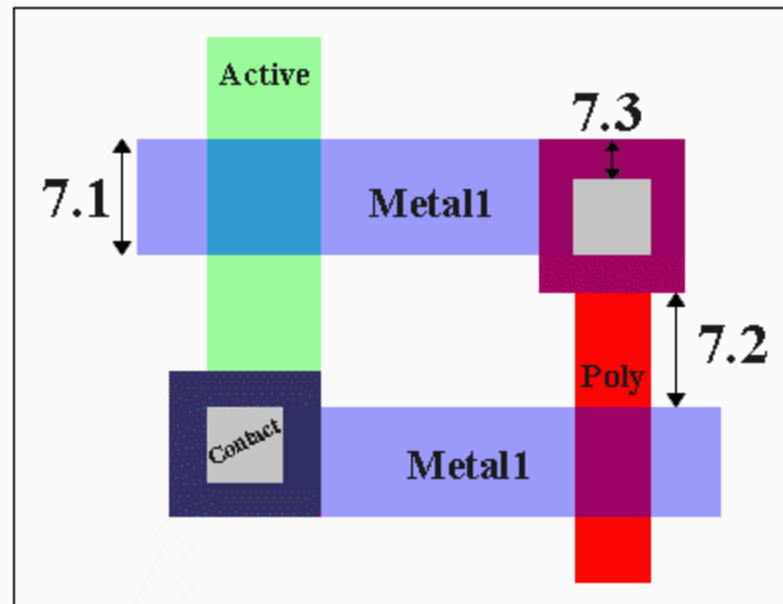
  

Simple Contact to Active

Alternative Contact to Active

# SCMOS Layout Rule – Metal 1

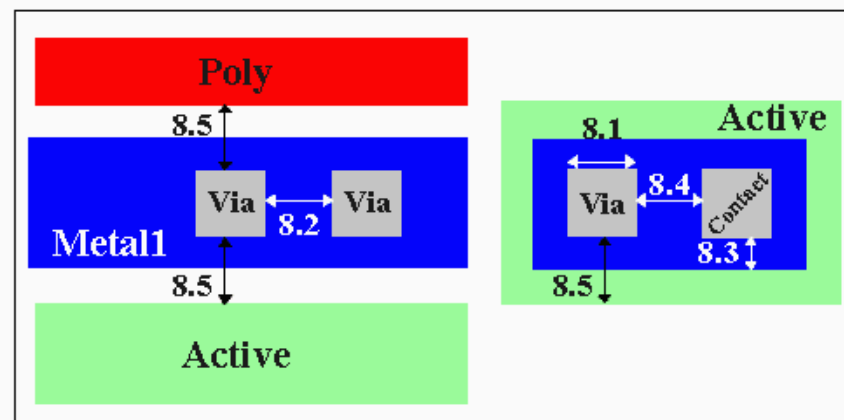
Rule	Description	Lambda		
		SCMOS	SUBM	DEEP
7.1	Minimum width	3	3	3
7.2	Minimum spacing	2	3	3
7.3	Minimum overlap of any contact	1	1	1
7.4	Minimum spacing when either metal line is wider than 10 lambda	4	6	6





# SCMOS Layout Rule – Via 1

Rule	Description	Lambda					
		2 Metal Process			3+ Metal Process		
		SCMOS	SUBM	DEEP	SCMOS	SUBM	DEEP
8.1	Exact size	2 x 2	n/a	n/a	2 x 2	2 x 2	3 x 3
8.2	Minimum via1 spacing	3	n/a	n/a	3	3	3
8.3	Minimum overlap by metal1	1	n/a	n/a	1	1	1
8.4	Minimum spacing to contact for technology codes mapped to processes that do not allow <a href="#">stacked vias</a> (SCNA, SCNE, SCN3M, SCN3MLC)	2	n/a	n/a	2	2	n/a
8.5	Minimum spacing to poly or active edge for technology codes mapped to processes that do not allow <a href="#">stacked vias</a> (NOTE: list is not same as for 8.4)	2	n/a	n/a	2	2	n/a



# SCMOS Layout Rule – Metal 2

Rule	Description	Lambda					
		2 Metal Process			3+ Metal Process		
		SCMOS	SUBM	DEEP	SCMOS	SUBM	DEEP
9.1	Minimum width	3	n/a	n/a	3	3	3
9.2	Minimum spacing	3	n/a	n/a	3	3	4
9.3	Minimum overlap of via1	1	n/a	n/a	1	1	1
9.4	Minimum spacing when either metal line is wider than 10 lambda	6	n/a	n/a	6	6	8

